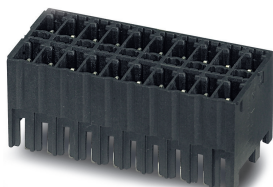


Printed-circuit board connector - MCDNV 1,5/20-G1-3,5 P14THR - 1953198

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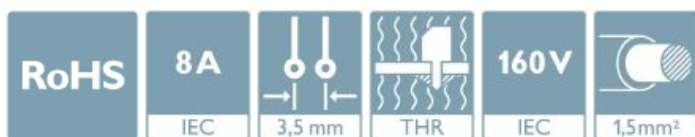


PCB header, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Tin, type of contact: Male connector, Number of potentials: 40, Number of rows: 2, Number of positions per row: 20, number of connections: 40, product range: MCDNV 1,5/..-G1-THR, pitch: 3.5 mm, mounting: THR soldering, pin layout: Linear pinning, solder pin [P]: 1.4 mm, plug-in system: MINI COMBICON, Locking: without, type of packaging: packed in cardboard, The pin length is 1.4 mm. User information and design recommendations on Through Hole Reflow Technology can be found at: Downloads".

The figure shows a 10-pos. version with 20 contacts

Your advantages

- ✔ Designed for integration into the SMT soldering process
- ✔ Vertical connection enables multi-row arrangement on the PCB
- ✔ Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- ✔ Conductor connection on several levels enables higher contact density



Key Commercial Data

Packing unit	50 pc
GTIN	
GTIN	4017918920357

Technical data

Item properties

Brief article description	Feed-through header
Plug-in system	MINI COMBICON
Type of contact	Male connector
Range of articles	MCDNV 1,5/..-G1-THR
Pitch	3.5 mm
Number of positions	20
Mounting type	THR soldering
Pin layout	Linear pinning
Locking	without

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Technical data

Item properties

Number of levels	2
Number of connections	40
Number of potentials	40
Pin connector pattern alignment	Standard

Electrical parameters

Nominal current	8 A
Nom. voltage	160 V
Rated voltage (III/3)	160 V
Rated voltage (III/2)	160 V
Rated voltage (II/2)	250 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 - 3 µm Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 µm Ni)

Material data - housing

Housing color	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Flange specifications

Type of locking	without
Mounting flange	without

Dimensions for the product

Caption	Schematische Abbildung - weitere Details siehe Produktfamilienzeichnung im Download Center
Length [l]	15.2 mm
Width [w]	71.5 mm
Height [h]	14.7 mm
Pitch	3.5 mm

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Technical data

Dimensions for the product

Height (without solder pin)	13.3 mm
Solder pin [P]	1.4 mm
Pin spacing	3.50 mm
Pin dimensions	0.8 x 0.8 mm

Dimensions for PCB design

Hole diameter	1.4 mm
Pin spacing	3.50 mm

Packaging information

Type of packaging	packed in cardboard
Pieces per package	50
Denomination packing units	Pcs.

General product information

Type of note	Details for soldering processes
Note	Processing using reflow processes in compliance with IEC 60068-2-58 or DIN EN 61760-1 (latest version) Moisture Sensitive Level (MSL) = 1 according to IPC/JEDEC J-STD-020-C
Type of note	Details for soldering processes
Note	Processing using reflow processes in compliance with IEC 60068-2-58 or DIN EN 61760-1 (latest version) Moisture Sensitive Level (MSL) = 1 according to IPC/JEDEC J-STD-020-C

Processing notes

Process	Reflow/wave soldering
Specification	Following IPC/JEDEC J-STD-020D.1:2008-03
	Following IEC 61760-1:2006-04
	Following IEC 60068-2-58:2005-02
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Air clearances and creepage distances

Clearances and creepage distances	IEC 60664-1:2007-04
Specification	IEC 60664-1:2007-04
Minimum clearance - inhomogeneous field (III/3)	1.5 mm
Minimum clearance - inhomogeneous field (III/2)	1.5 mm

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Technical data

Air clearances and creepage distances

Minimum clearance - inhomogeneous field (II/2)	1.5 mm
Minimum creepage distance value (III/3)	2.5 mm
Minimum creepage distance value (III/2)	1.6 mm
Minimum creepage distance value (II/2)	2.5 mm

Mechanical tests (A)

Test specification	IEC 61984
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N
Polarization when inserted requirement >20 N	Test passed
Contact holder in insert requirements >20 N	Test passed

Durability tests (B)

Specification	IEC 60512-9-1:2010-03
Contact resistance R ₁	1.8 mΩ
Insertion/withdrawal cycles	25
Contact resistance R ₂	1.9 mΩ
Impulse withstand voltage at sea level	2.95 kV

Thermal tests (C)

Specification	IEC 60512-5-1:2002-02
Number of positions	20
Upper limiting temperature requirements <100 °C	Test passed

Climatic tests (D)

Specification	ISO 6988:1985-02
Cold stress	-40 °C/2 h
Thermal stress	100 °C/168 h
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Impulse withstand voltage at sea level	2.95 kV
Power-frequency withstand voltage	1.39 kV

Environmental and durability tests (E)

Specification	IEC 61984:2008-10
Result, degree of protection, IP code	Finger safety with IP20 test finger

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 - 60.1 Hz)
Acceleration	5 g (60.1 - 150 Hz)

Printed-circuit board connector - MCDNV 1,5/20-G1-3,5 P14THR - 1953198

Technical data

Vibration test

Test duration per axis	2.5 h
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Standards and Regulations

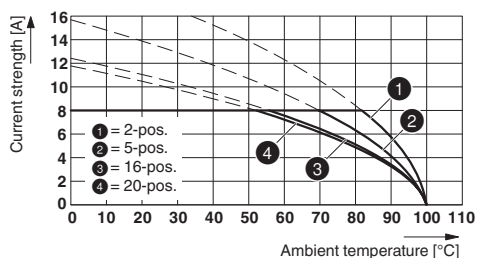
Connection in acc. with standard	EN-VDE
	CUL
Flammability rating according to UL 94	V0

Environmental Product Compliance

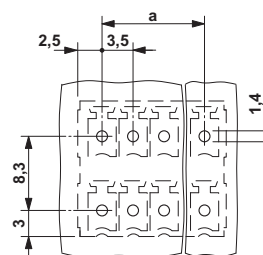
China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

Drawings

Diagram



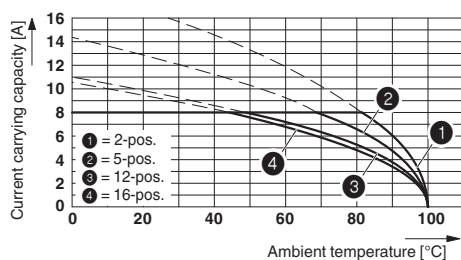
Drilling diagram



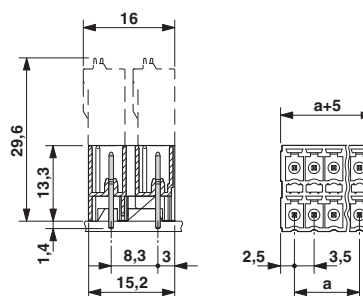
Type: FMC 1,5/...-ST-3,5 with MCDNV 1,5/...-G1-3,5 P...THR

*) ≤ 8-pos. = 1.3 / > 8-pos. = 1.4

Diagram



Dimensional drawing



Type: FMCD 1,5/...-ST-3,5 with MCDNV 1,5/...-G1-3,5 P...THR

Classifications

eCl@ss

eCl@ss 4.0	272607xx
eCl@ss 4.1	27260701
eCl@ss 5.0	27260701
eCl@ss 5.1	27260700

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Classifications

eCl@ss

eCl@ss 6.0	27260700
eCl@ss 7.0	27440402
eCl@ss 9.0	27440402

ETIM

ETIM 3.0	EC001121
ETIM 4.0	EC002637
ETIM 6.0	EC002637
ETIM 7.0	EC002637

UNSPSC

UNSPSC 6.01	30211810
UNSPSC 7.0901	39121409
UNSPSC 11	39121409
UNSPSC 12.01	39121409
UNSPSC 13.2	39121409
UNSPSC 19.0	39121409

Accessories

Accessories

Coding element

Coding profile - CP-MSTB - 1734634

Coding profile, is inserted into the slot on the plug or inverted header, red insulating material



Labeled terminal marker

Marker card - SK 3,81/2,8:FORTL.ZAHLEN - 0804109



Marker card, Card, white, labeled, horizontal: consecutive numbers 1 ... 10, 11 ... 20, etc. up to 91 ... (99)100, mounting type: adhesive, for terminal block width: 3.81 mm, lettering field size: 3.81 x 2.8 mm

Additional products

Printed-circuit board connector - MCDNV 1,5/20-G1-3,5 P14THR - 1953198

Accessories

Printed-circuit board connector - FMC 1,5/20-ST-3,5 - 1952445



PCB connector, nominal cross section: 1.5 mm², color: green, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Tin, type of contact: Female connector, Number of potentials: 20, Number of rows: 1, Number of positions per row: 20, number of connections: 20, product range: FMC 1,5/..-ST, pitch: 3.5 mm, connection method: Push-in spring connection, conductor/PCB connection direction: 0 °, plug-in system: MINI COMBICON, Locking: without, type of packaging: packed in cardboard

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